

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT4958254

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUNG-CHUNG PAN	01/16/2018
CHANG-YU TSAI	01/16/2018
CHING-CHUNG HU	01/16/2018
MING-PAO CHEN	01/16/2018
CHI SHEN	01/16/2018
WEI-CHIEH LIEN	01/16/2018
RECEIVING PARTY DATA	
Name:	EPISTAR CORPORATION
Street Address:	5, LI-HSIN 5TH RD., SCIENCE-BASED INDUSTRIAL PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	R.O.C. 300
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15875735
CORRESPONDENCE DATA	
Fax Number:	(703)519-9958
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7035199951
Email:	docket@dcpatent.com
Correspondent Name:	DITTHAVONG & STEINER, P.C.
Address Line 1:	44 CANAL CENTER PLZ.
Address Line 2:	STE. 322
Address Line 4:	ALEXANDRIA, VIRGINIA 22314
ATTORNEY DOCKET NUMBER:	P8657US01
NAME OF SUBMITTER:	BRIAN K. SEIDLECK
SIGNATURE:	/Brian K. Seidleck/
DATE SIGNED:	05/11/2018

Total Attachments: 6

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COMBINED DECLARATION and ASSIGNMENT (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76)

Title of Invention	SEMICONDUCTOR DEVICE
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As the below named inventor, I hereby declare that:

This declaration is directed to: The attached application, or United States application or PCT international application number _____ filed on _____

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the application and am aware of the duty to disclose to the US Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR § 1.56.

ASSIGNMENT

For good and valuable consideration, the receipt, sufficiency and adequacy of which are hereby acknowledged, I hereby sell, assign, and transfer to Epistar Corporation, having a principle place of business at 5, Li-hsin 5th Rd., Science-based Industrial Park, Hsinchu, Taiwan, R.O.C. 300, and its successors, assigns, and legal representatives, my entire right, title and interest in and to the invention listed above, together with the Application, any and all Patents that may issue for the United States and all foreign countries (including the right to claim priority under the terms of the International Convention and any other relevant International Treaties and Arrangements from the aforesaid application), in and to any and all improvements that are disclosed in the above-noted application, and in and to any reissues, renewals, continuations, continuation-in-parts, divisionals or extensions thereof that have been or shall be filed in the United States and all foreign countries on any of said improvements.

I agree that I will communicate to the assignee or its representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, and reissue applications, execute all necessary assignment papers to cause any and all Patents to be issued to the assignee, make all rightful oaths, and, generally do everything possible to aid said assignee, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

LEGAL NAME OF INVENTOR (Given name FAMILY NAME)

Inventor: Yung-Chung Pan

Date: 2018/1/16

Signature: Yung-Chung Pan

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LEGAL NAME OF INVENTOR (Given name FAMILY NAME)

Inventor: Chang-Yu Tsai Date: 2018/1/16

Signature: Chang-Yu Tsai

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LEGAL NAME OF INVENTOR (Given name FAMILY NAME)

Inventor: Ching-Chung Hu

Date: 2018 / 1 / 16

Signature: Ching-Chung Hu

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LEGAL NAME OF INVENTOR (Given name FAMILY NAME)

Inventor: Ming-Pao Chen Date: 2018/1/16

Signature: Ming Pao Chen

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LEGAL NAME OF INVENTOR (Given name FAMILY NAME)

Inventor: Chi Shen Date: 2018 / 1 / 16

Signature: Chi Shen

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LEGAL NAME OF INVENTOR (Given name FAMILY NAME)

Inventor: Wei-Chieh Lien

Date: 2018/11/16

Signature: Wei-Chieh Lien